

34×34 , 3.2 Gbps Asynchronous Digital Crosspoint Switch

Data Sheet **[AD8152](https://www.analog.com/AD8152?doc=AD8152.pdf)**

FEATURES

Low cost

Low power: 2.5 V (outputs disabled) 34 × 34, fully differential, nonblocking array 3.2 Gbps per port NRZ data rate Wide power supply range: 2.5 V to 3.3 V LVTTL or LVCMOS level control inputs at 2.5 V to 3.3 V Low channel jitter: 45 ps p-p Drives a backplane directly Programmable output swing 100 mV to 1600 mV p-p differential 50 Ω on-chip input/output termination User controlled voltage at the load Minimizes power dissipation Dual rank latches Available in 256-ball BGA_ED package

APPLICATIONS

Fiber optic network switching High speed serial backplane routing to OC-48 with FEC Gigabit ethernet Digital video (HDTV) Data storage networks

GENERAL DESCRIPTION

The AD8152 is a breakthrough cross point switch offering a large switch array (34×34) on very little power, typically 2.0 W. Additionally, the device operates at data rates up to 3.2 Gbps per port, making it suitable for Sonet/SDH OC-48 with forward error correction (FEC).

The useful supply voltage range of the AD8152 allows the user to operate at LVPECL/CML data levels down to 2.5 V. The control interface is low voltage transistor transistor logic (LVTTL) or low voltage complementary metal-oxide (LVCMOS) compatible on 2.5 V to 3.3 V.

The fully differential signal path of the AD8152 reduces jitter and crosstalk and allows the use of smaller single-ended voltage swings. The device is offered in a 256-ball BGA_ED package that operates over the industrial temperature range of 0°C to 85°C.

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REVISION HISTORY

1/2003—Rev. 0 to Rev. A

9/2002—Revision 0: Initial Version

SPECIFICATIONS

At 25°C, VCC = 2.5 V to 3.3 V, VEE = 0 V, load resistor (R_L) = 50 Ω , and differential output swing = 800 mV p-p, unless otherwise noted.

Table 1.

TIMING SPECIFICATIONS

Table 2 to [Table 11](#page-4-0) list the timing specifications in detail.

Table 2. Bit Descriptions of the Register Address and Register Data Buses

Table 3. A6 Bit Description

Table 4. Connection Data and Address Programming Examples

¹ Where x is either P or N, the positive or negative differential signals for the input and output ports.

Table 5. Output Current Level Data and Address Programming Examples¹

¹ N/A means don't care.

Table 6. Basic Control Strobe Function¹

¹ N/A means don't care.

Table 7. First Rank Write Cycle

Parameter	Description	Test Conditions/Comments	Min	Typ	Max	Unit
tcsw	Chip select to write enable, setup time	$T_A = 25^{\circ}$ C, VCC = 3.3 V	0			ns
t _{ASW}	Address to write enable	$T_A = 25^{\circ}$ C, VCC = 3.3 V	0			ns
t _{nsw}	Data to write enable	$T_A = 25^{\circ}$ C, VCC = 3.3 V				ns
t_{CHW}	Chip select from write enable, hold time	$T_A = 25^{\circ}$ C, VCC = 3.3 V	0			ns
t _{AHW}	Address from write enable	$T_A = 25^{\circ}$ C, VCC = 3.3 V	0			ns
t _{DHW}	Data from write enable	$T_A = 25^{\circ}$ C, VCC = 3.3 V	0			ns
twp	Width of write enable pulse	$T_A = 25^{\circ}$ C, VCC = 3.3 V	10			ns

Table 8. Second Rank Update Cycle

Table 9. Transparent Update Cycle

¹ Not shown in Figure 4.

Table 10. Second Rank Readback Cycle

¹ At 25°C, VCC = 2.5 V to 3.3 V, VEE = 0 V, R_L = 50 Ω, and differential output swing = 800 mV p-p, unless otherwise noted.

Table 11. Asynchronous Reset

Timing Diagrams

Figure 6. Asynchronous Reset

ABSOLUTE MAXIMUM RATINGS

Table 12.

¹ Specification is for the device in free air (T_A = 25°C): θ_{JA} = 9.2°C/W at still air.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

MAXIMUM POWER DISSIPATION

The maximum power that can be safely dissipated by the AD8152 is limited by the associated rise in junction temperature. The maximum safe junction temperature for plastic encapsulated devices is determined by the glass transition temperature of the plastic, approximately 150°C. Temporarily exceeding this limit may cause a shift in parametric performance due to a change in the stresses exerted on the die by the package. Exceeding a junction temperature of 175°C for an extended period can result in device failure. To ensure proper operation, it is necessary to observe the maximum power derating curves shown in [Figure 7.](#page-7-4)

Figure 7. Maximum Power Dissipation vs. Ambient Temperature

THERMAL RESISTANCE

Thermal performance is directly linked to printed circuit board (PCB) design and operating environment. Close attention to PCB thermal design is required.

θ_{IA} is the thermal resistance ambient environment and θ_{IC} TOP is the thermal resistance to the top of the package.

Thermal resistance values specified i[n Table 13](#page-7-5) are simulated based on JEDEC specifications (unless specified otherwise) and must be used in compliance with JESD51-12.

Table 13. Thermal Resistance

¹ Using enhanced heat removal (PCB, heat sink, and airflow) technique improves thermal resistance values.

² For the $θ_{JC_TOP}$ test, 100 μm thermal insulation material (TIM) is used. TIM is assumed to have 3.6 W/mK.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

Figure 8. Pin Configuration

Table 14. Pin Function Descriptions

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1 I/O stands for input/output.

02984-008

02984-009

02984-010

TYPICAL PERFORMANCE CHARACTERISTICS

2.5 V supply, VCC = VTTI = VTTO, data rate = 3.2 Gbps, PRBS 2²³-1, differential output swing = 800 mV p-p, R_L = 50 Ω, and input amplitude = 0.4 V p-p single-ended, unless otherwise noted.

02984-005

Figure 9. Eye Pattern, 3.2 Gbps

Figure 10. Jitter at 3.2 Gbps

Figure 11. Response, 3.2 Gbps, 32-Bit Pattern 1111 1111 0 000 0000 1010 1010 1100 1100

Figure 14. Response, 1.5 Gbps, 32-Bit Pattern 1111 1111 0000 0000 1010 1010 1100 1100

02984-007

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Figure 19. Crosstalk, 3.2 Gbps, Attack Signal Off (See [Figure 33\)](#page-17-1)

Figure 20. Crosstalk, 3.2 Gbps, Attack Signal On (See [Figure 33\)](#page-17-1)

Figure 26. Jitter vs. Programmed Iout

Figure 23. Peak-to-Peak Jitter vs. Input Common-Mode Level

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Figure 28. Propagation Delay vs. Temperature

Figure 29. Propagation Delay vs. Supply Voltage

Figure 30. Iout Vs. Iout Code

TEST CIRCUITS

Figure 33. Crosstalk Test Circuit

THEORY OF OPERATION

The AD8152 control interface receives and stores the desired connection matrix and output levels for the 34 input and 34 output signal pairs. The interface consists of 34 rows of doublerank 6-bit latches, one for each output. The 6-bit data-word stored in these latches indicates to which (if any) of the 34 inputs the output is connected, as well as the full-scale output current.

One output at a time can be preprogrammed by addressing the output and writing the desired connection data or output current into the first rank of latches. This process can be repeated until all desired output changes are preprogrammed. All output connections can then be programmed simultaneously by passing the data from the first rank of latches into the second rank. The output connections always reflect the data programmed into the second rank of latches and do not change until the first rank of data is passed into the second rank.

If necessary for system verification, the data in the second rank of latches can be read back from the control interface.

At any time, a reset pulse can be applied to the control interface to globally reset the appropriate second rank data bits, disabling all 34 signal output pairs and resetting the output currents. To facilitate multiple chip address decoding, there is a chip select pin. All logic signals except the reset pulse are ignored, unless the chip select pin is active. The chip select pin disables only the control logic interface and does not change the operation of the signal matrix. The chip select pin does not power down any of the latches thus, any data programmed in the latches is preserved.

All control pins are level sensitive, not edge triggered.

CONTROL PIN DESCRIPTION

A0 to A6 Inputs

A0 to A6 output address pins. The binary encoded address applied to the lower A5 to A0 input pins determines which of the 34 outputs is being programmed (or being read back). The most significant bit, A6, determines whether the data pins contain information for the connection register bank or the output level register bank. Using the broadcast address, A5 to A0 = 111111 simultaneously programs data into all of the outputs.

D5 to D0 Inputs/Outputs

D0 to D5 input configuration or output level data pins. In write mode, when the bank selection bit A6 is low, the binary encoded data applied to Pin D5 to Pin D0 determine which of the 34 inputs is to be connected to the output specified with the A5 pin to A0 pin. The most significant bit is D5 and the least significant bit is D0. To disable an output completely, the input address D5 to D0 = 111111 must be written into the input configuration bank at the desired output address.

In write mode, when the bank selection bit, A6, is high, the binary encoded data applied to Pin D3 to Pin D0 indicate the output current level to be used for the output specified with the A5 pin to A0 pin. The reset default is 0111 for 16 mA. Each LSB is 2 mA.

In readback mode, Pin D5 to Pin D0 are low impedance outputs indicating the data-word stored in the second rank for the output specified with the A5 pin and A0 pin and the bank specified with the A6 bit. The readback drivers are designed to drive high impedances only. Therefore, external drivers connected to D5 to D0 must be disabled during readback mode.

WE Input

WE is the first rank write enable pin. Forcing this pin to logic low allows the data on Pin D5 to Pin D0 to be stored in the first rank latch for the output specified by Pin A6 to Pin A0. The WE pin must be returned to a logic high state after a write cycle to avoid overwriting the first rank data.

UPDATE Input

UPDATE is the second rank write enable pin. Forcing this pin to logic low allows the data stored in all 34 first rank latches (in both banks) to be transferred to the second rank latches. The signal connection matrix is reprogrammed when the second rank data and levels are changed. UPDATE is a global pin, transferring all 34 rows of data at once. It is not necessary to program the address pins. After initial power-up of the device, the first rank data is undefined. It is recommended to preprogram all 17 outputs before performing the first update cycle.

RE Input

RE is the second rank read enable pin. Forcing this pin to logic low enables the output drivers on the bidirectional D5 pin to D0 pin, entering the readback mode of operation. By selecting an output address with the A6 pin to A0 pin and forcing $\overline{\text{RE}}$ to logic low, the 6-bit data stored in the second rank latch for that output address is written to the D5 pin to D0 pin. It is not recommended to write data to the D5 pin to D0 pin externally while in readback mode. The $\overline{\text{RE}}$ pin is a higher priority pin than the $\overline{\text{WE}}$ pin. Therefore, first rank programming is not possible while in readback mode.

CS Input

CS is the chip select pin. This pin must be forced to logic low to program or receive data from the logic interface, with the exception of the RESET pin, described in the [RESET](#page-18-2) Input section. This pin has no effect on the signal pairs and does not alter any of the stored control data.

RESET Input

RESET is the global output disable pin. Forcing the RESET pin to logic low disables all outputs and, regardless of the state of any other pins, sets both ranks of all 34 input connection latches. This logic low immediately disables the 34 output signal pairs in the matrix. The output level information is also changed. It is necessary to momentarily hold RESET at a logic low state when powering up the AD8152 to avoid random internal contention where multiple inputs may be connected to one output. The RESET pin is not gated by the state of the chip select pin, \overline{CS} .

[AD8152](https://www.analog.com/AD8152?doc=AD8152.pdf) Data Sheet

Control Interface Levels

The AD8152 control interface shares the data path supply pins, VCC and VEE. The potential between the positive logic supply (VCC) and the negative supply (VEE) must be at least 2.25 V and no more than 3.63 V. Regardless of the supply, the logic threshold is approximately one-half the supply range, allowing the interface to be used with most LVCMOS and LVTTL logic drivers.

Output Addressing

The AD8152 is programmed using a memory interface module, with parallel address and data buses. Six bits, [A5:A0], are used to address the outputs (se[e Table 5\)](#page-3-1). By setting the decimal value of these address bits to a value from 0 to 33 inclusive, one of the 34 outputs is uniquely addressed.

One additional decimal code, 63 (all 1s), is used for the broadcast mode. If this address is selected, then all outputs receive the same programming. The remaining addresses in the register space are not valid and are reserved, Decimal Code 34 to Decimal Code 66 inclusive.

Connection and Output Current Programming

A seventh address bit (A6) determines which of two types of programming is selected. If $A6 = 0$, connection matrix programming (connecting an input to an output) is selected. If A6 = 1, output current programming is selected.

Output Current Programming

A current source in each output can be digitally programmed to any one of 16 different current levels. Changing these current levels changes the amplitude of the output swing that is developed across the internal 50 Ω termination resistors.

To program the current for a particular output, the address is set on Control Pin A5 to Control Pin A0 (Decimal Code 00 to Decimal Code 33), while A6 is set to 1. The four LSBs of the data address, [D3:D0], are then used to select one of the 16 output current levels. D4 and D5 assume the don't care value for output current programming (se[e Table 5\)](#page-3-1).

To program all outputs to the same current level, set the address bus, A5 to A0, to broadcast Decimal Code 63 with A6 = 1. Address Pin D3 to Address Pin D0 then program all output currents to the same level.

When the current code is set to 0000, a minimum current level of 2 mA is obtained. For any other code, the current can be calculated by (current code) \times 2 mA + 2 mA. Refer to Table 5 for current code values. For example, 16 mA can be programmed by Decimal Code 7. This value is 7×2 mA + 2 mA = 16 mA.

Using the Data Bus

After determining which output to program (or broadcast to all outputs) and which type of programming (connection/output current) to use, the data bits, [D5:D0], then further define the programming action.

If connection programming $(A6 = 0)$ is selected, the data bits select the input that is to be connected to the addressed output. If the broadcast address is selected, the data bits select the input that is connected to all 34 outputs (see [Table 4\)](#page-3-2).

A disable code (Bits[D5:D0] = 63 decimal value, or all 1s) disables (and powers down) the particular output that is addressed. A broadcast can be put into effect by setting Decimal Code 63 on both the address bus and the data bus along with $A6 = 0$.

Register Control Signals

Several single-ended logic input pins control the register loading associated with the address and data buses described in the [Using the Data Bus s](#page-19-0)ection. The control functions are tabulated in [Table 6](#page-3-3)

There are dual ranks of registers for the data that programs the AD8152. The first rank registers accumulate the data for the various outputs as they are being programmed one by one. The second rank registers actually control the functions of the device.

The RESET signal resets the connection matrix, disables all outputs, and sets all of the output currents to a default condition at Decimal Code 7. This signal sets the output current to a nominal value of 16 mA. The data in the first rank latches is also reset by the assertion of RESET.

The \overline{CS} signal enables the control interface. If several devices are used in a system with the other control signals bussed, the \overline{CS} signal can select an individual device to change the programming.

The WE signal enables writing data to the first rank registers. This data does not immediately affect the features of the AD8152.

The UPDATE signal transfers the data from the first rank registers to the second rank registers. After the UPDATE signal is asserted, the data actively controls the AD8152 functions.

The second rank registers can be read back through the data bus. The output is addressed on Bits[A5:A0] and the connection or current is selected via A6. Asserting $\overline{\text{RE}}$ causes the second rank data to appear on the data bus. The $\overline{\text{RE}}$ function dominates over WE if both are asserted at the same time. Broadcast readback is not permitted.

Some typical programming waveforms for the control signals are provided in [Figure 34.](#page-19-1)

Internal Input/Output Termination

The AD8152 includes 50 Ω termination resistors to match single-ended 50 Ω or 100 Ω transmission lines. All of the input termination resistors connect to one common point called VTTI. Similarly, each of the output termination resistors connects to one common point called VTTO. The voltage can be set independently at VTTI and VTTO to accommodate various interface architectures.

Input Coupling

One way to simplify the input circuit and make it compatible with a wide variety of driving devices is to use ac coupling. This ac coupling has the effect of isolating the dc common-mode levels of the driver and the AD8152 input circuitry. For example, the XAUI interconnect specification for 10 Gbps Ethernet requires ac coupling to ensure that there are no interactions of dc levels between the transmitting and receiving devices.

AC coupling requires that the signal patterns have no long-term dc component, which may occur in any random data stream. Codes such as 8-bit/10-bit, called for in the XAUI specification, are used in many data communications systems to ensure that the data pattern maintains a common-mode balance. This is accomplished by run length limiting (RLL), which sets a maximum limit for the number of 1s or 0s that can occur consecutively. In addition, residual dc components are monitored and modified by keeping track of the running disparity, excess of 1s vs. 0s, or vice versa.

For the AD8152 inputs, ac coupling requires a capacitor in series with each single-ended input signal, as shown in [Figure 35.](#page-20-0) AC coupling is recommended to be done in a manner that does not interfere with the high speed signal integrity of the PCB board. The two critical variables are setting the proper voltage for VTTI and selecting the correct value of coupling capacitors.

Figure 35. AC Coupling Input Signal from AD8152

On the AD8152 side of the input coupling capacitor, the average value of the single-ended input voltage is at the voltage set at VTTI. The range of allowable voltages is a function of the acceptable input voltages of the active circuitry of the AD8152 inputs and the amplitude of the input signal. The operating input range of the AD8152 extends from VCC $+0.2$ V to 0.8 V above VEE.

The total range that is occupied by the input signal is the average value (as established by the voltage applied to VTTI) plus or minus one half the single-ended swing of the signal. For a standard 800 mV p-p differential signal, the single-ended swing is 400 mV p-p. Thus, the signal swings ±200 mV around the average value equal to VTTI.

If VTTI is set equal to VCC, the single-ended signal meets the specifications where the highest input voltage level does not exceed the design compliance threshold of VCC + 0.2 V. The lowest signal-ended input voltage level must be greater than 0.8 V above VEE to maintain compliance with the design specification.

With ac-coupled inputs, there is no power consumption advantage associated with varying VTTI. As a practical matter, it may be desirable to set VTTI at the same voltage as VTTO so that only one supply is necessary.

Output Coupling

Each single-ended output of the AD8152 has a 50 Ω termination resistor that ties to VTTO. The differential termination tied to VTTO is 25 $Ω$. When VTTO is varied, it changes the commonmode levels of the outputs and the power dissipation of the output stages when enabled.

The individual output currents are programmable. Varying this output current changes the lower level of the output voltage (and thus the peak-to-peak swing) and changes the power dissipation in the output stages. To obtain a standard 800 mV p-p differential output (single-ended = 400 mV p-p), it is recommended to program the output current to 16 mA.

If the AD8152 drives another device that is ac-coupled, there is no interaction of the dc levels on each side of the coupling capacitors (se[e Figure 36\)](#page-20-1). The dc levels for the AD8152 can be calculated independently of the levels of the driven device. The upper allowable setting for VTTO is 0.2 V higher than VCC.

To save power, VTTO can be lowered. The lowest level for VTTO is determined by the lowest output level allowable (V_{OL}) by the AD8152 output when the output signal is logically low. It is recommended that the output does not go lower than 1.0 V below VCC. If the single-ended swing of an output is 400 mV p-p, the lowest that VTTO can go is 0.6 V below VCC. For more information on V_{OL} , see Figure 25.

Figure 36. AC Coupling Output Signal from AD8152

AD8152 POWER CONSUMPTION

Several sections of the AD8152 draw varying levels of power depending on the supply voltages, the type of input/output coupling used, and the status of the AD8152 operation. [Figure 37](#page-21-1) shows a block diagram of these sections. The AD8152 contains six main circuit blocks that determine the overall power consumption of the device[. Table 15](#page-22-0) summarizes the power consumption of each section and is a useful guide as the next sections are reviewed.

The first section is the input termination resistors. The power dissipated in the termination resistors is the result of being driven by the respective driving stage. DC power may also be dissipated in the input termination resistors if the inputs are dccoupled and the driving source reference is a dc voltage that is not equal to VTTI.

In the next section, the active part of the input stages, each input is powered only when it is selected. If an input is not selected, it is powered down. Thus, the total number of active inputs affects the total power consumption. The core of the device performs the crosspoint switch matrix that draws a fixed quiescent current whenever the AD8152 is powered from VCC to VEE.

An output predriver section draws a current that is proportional to the programmed output current, Iour. This current always flows from VCC to VEE. The predriver current is treated separately from the output current, which flows from VTTO, and may not be the same voltage as VCC.

The final section is the outputs. For an individual output, the programmed output current flows through two separate paths. One path is the on-chip termination resistor, and the other path is the transmission line and the destination termination resistor. The nominal parallel impedance of these two paths is 25 Ω . The sum of these two currents flows through the switches and the current source of the AD8152 output circuit, and then out through VEE.

The power dissipated in the transmission line and destination resistor does not dissipate in the AD8152 but must be supplied from the power supply and is factored into the overall system power. The current in the on-chip termination resistors and output current source dissipates power in the AD8152.

Figure 37. Power Consumption Block Diagram

Table 15. Power Consumption

Input Termination Resistors

The power dissipated in the input termination resistors is delivered by the driving source. First, assume the driving waveform for an individual input is a differential square wave with an amplitude of V_{INPP} . Then the power dissipated in this input is $(V_{\text{INPP}})^2/2R_{\text{TERM}}$, where R_{TERM} is the termination resistor.

If dc coupling is used, a dc current flows from VTTI through the termination resistors if the dc voltage of the drive circuit is not equal to VTTI. The additional power in each input termination resistor is the current multiplied by the 50 Ω value of the input terminations.

For a point of reference, assume a channel has a sinusoidal input of 800 mV p-p differential. The power dissipated for a single input is 3.2 mW. If all 34 input channels are driven the same, the power in the input terminations is 109 mW.

Input Stage

The input stages are powered down when not in use. Approximately 2 mA flows through an enabled input from VCC to VEE. Thus, the power dissipated by an enabled input is 5 mW for a supply of 2.5 V and 6.6 mW for a 3.3 V supply. When all 34 inputs are enabled, the total power consumed in the input stage is approximately 170 mW (VCC = 2.5 V) and 224 mW $(VCC = 3.3 V).$

Switch Matrix

The switch matrix draws a fixed 32 mA when the AD8152 is powered. This current flows from VCC to VEE. The power dissipation from this current is 80 mW at 2.5 V and 106 mW at 3.3 V.

Output Predrivers

The output predrivers draw additional current when each output is enabled. This extra current is proportional to the programmed output current. The extra predriver current for a channel is 25% of the programmed output current for that channel. This current also flows from VCC to VEE.

When an output is enabled and programmed to 16 mA, an additional 4 mA flows in the predriver section. This predriver current dissipates either 10 mW at 2.5 V or 13.2 mW at 3.3 V for an individual output.

For all enabled 34 outputs and programmed to 16 mA, the predriver power is 340 mW at 2.5 V or 449 mW at 3.3 V.

OUTPUTS

The output current is forced by a current source that is programmed to a variable amount of current from 2 mA to 32 mA in 2 mA steps. For the two logic switch states, this output current flows through an on-chip termination resistor and a parallel path to the destination device and termination resistor. The power in this parallel path is not dissipated by the AD8152.

The nominal programmed output current is 16 mA. With the two parallel 50 Ω resistors at each collector (25 Ω equivalent), this current creates a 400 mV p-p swing in each half of the circuit. The differential output voltage is 800 mV p-p.

Under steady state conditions and with a data pattern that is run length limited so that the low frequency content is significantly higher than the RC pole formed by the coupling capacitor and the termination resistors, the common-mode level at the AD8152 outputs is 400 mV lower than VTTO. Each output then swings ±200 mV from this level, which is a 400 mV p-p single-ended output swing.

At the high level, there is 200 mV across the termination resistor, which dissipates a power of 0.8 mW. At the low level, the 600 mV across the termination resistor dissipates a power of 7.2 mW. Because the output signal is essentially 50% duty cycle, the average power dissipated is the average of these two values or 4 mW. By symmetry, the other differential output dissipates the same power. The total power dissipated through the on-chip termination resistor is approximately 8 mW per channel for each output, or 272 mW for all 34 outputs.

The full output current (from both on- and off-chip termination resistors) flows in the lower part of each output. This current flows only in the side that is on, or in the low state (V_{OL}) . This voltage is 600 mV below the dc level at VTTO.

Thus, for VTTO = 2.5 V, V_{OL} = 1.9 V, and the power dissipation for $I_{\text{OUT}} = 16 \text{ mA}$ is 30.4 mA. For all 34 channels, the power is 1.03 W.

If VTTO = 3.3 V, then V_{OL} = 2.7 V. The single power is 43.2 mW and the power for all 34 channels is 1.47 W.

If VTTO = 2.5 V, then the additional power is given by 16 mA \times $((2.5 V - (16 mA \times 25 \Omega)) = 33.6 mW$. Thus, the total AD8152 power dissipation for this output is 37.6 mW.

If all 34 outputs are enabled with the same I_{OUT}, the total power dissipation is 1.28 W. Thus, it can be seen that the outputs are the major contributor to the power dissipation.

Power Saving Considerations

Although the AD8152 power consumption is very low compared to similar devices, careful control of the operating conditions can yield even further power savings. Significant power reduction can be achieved by operating the device at a lower voltage. Compared to 3.3 V operation, a supply voltage of 2.5 V can result in power savings of about 25%. There is virtually no performance penalty when operating at lower voltage.

A second measure is to disable outputs when they are not being used, either on a static basis, if the output is not used, or on a dynamic basis, if the output does not have a constant stream of traffic.

Because the majority of the power dissipated is in the output stage, some of the flexibility can be used to lower the power consumption.

First, the output current can be programmed to the lowest programmable value to maintain bit error rate (BER) performance. If an output circuit always has a short length and the receiver has acceptable sensitivity, a lower output current can be used.

It is also possible to lower the voltage on VTTO to lower the power dissipation. The amount that VTTO can be lowered is dependent on the lowest V_{OL} of all the output. This V_{OL} value is determined by the output that is operating at the highest programmed output current because V_{OL} = VTTO – (I_{OUT} × 25 Ω).

OUTLINE DIMENSIONS

ORDERING GUIDE

 $1 Z =$ RoHS Compliant Part.

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